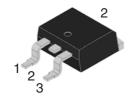
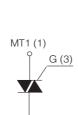
RoHS



STANDARD TRIAC

TO-263AB (D2PAK)





MT2 (2)

On-State Current

Gate Trigger Current

12 Amp

 \leq 100 mA

Off-State Voltage

400 V ÷ 800 V

FEATURES

- Glass/passivated die junctions
- Medium current Triac
- Ideal for automated placement
- Low thermal resistance
- High surge current capability
- Low forward voltage drop
- Solder dip 260°C, 10s
- Component in accordance to RoHS 2011/65/EU and WEEE 2002/96/EC
- Meets MSL level 3, per J-STD-020, LF maximum peak of 260° C

MECHANICAL DATA

- Case: TO-263AB (D2PAK). Epoxy meets UL 94V-0 flammability rating.
- Polarity: As marked on the body.
- **Terminals:** Matte tin plated leads, solderable per MIL-STD-750 Method 2026, J-STD-002 and JESD22-B102. Consumer grade, meets JESD 201 class 1A whisker test.

TYPICAL APPLICATIONS

Suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, induction motor starting circuits... or for phase control operation in light dimmers, motor speed controllers,

Maximun Ratings and Electrical Characteristics at 25°C

| SYMBOL | PARAMETER | CONDITIONS | Value | Unit |
|---------------------|---|---|------------|------------------|
| I _{T(RMS)} | RMS On-state Current (full sine wave) | All Conduction Angle, T _c = 105 °C | 12 | А |
| I _{TSM} | Non-repetitive On-State Current | Full Cycle, 60 Hz (t = 16.7 ms) | 110 | А |
| I _{TSM} | Non-repetitive On-State Current | Full Cycle, 50 Hz (t = 20 ms) | 100 | А |
| I ² t | Fusing Current | tp = 10 ms, Half Cycle | 50 | A ² s |
| I _{GM} | Peak Gate Current | 20 μs max. Tj = 125 °C | 4 | А |
| P _{G(AV)} | Average Gate Power Dissipation | Tj = 125 °C | 1 | W |
| dI/dt | Critical rate of rise of on-state current | $I_G = 2x I_{GT}, t_r \le 100 \text{ns}$ | 50 | A/µs |
| | | f = 120 Hz, T _j = 125 °C | | |
| T _j | Operating Temperature | | (-40 +125) | °C |
| T _{stg} | Storage Temperature | | (-40 +150) | °C |
| T _{sld} | Soldering Temperature | 10s max | 260 | °C |

| SYMBOL | PARAMETER | | Unit | | |
|-------------------|-----------------------------------|-----|------|-----|-------|
| OT MIDGE | 711711121211 | D | M | N | Oilit |
| V_{DRM}/V_{RRM} | Repetitive Peak Off State Voltage | 400 | 600 | 800 | V |

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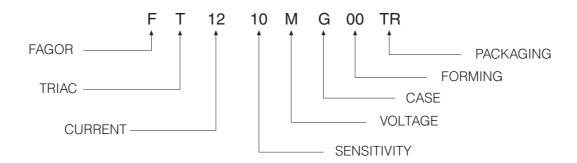


Electrical Characteristics at Tamb = 25 °C

| SYMBOL | PARAMETER CONDITIONS | | Quadrant | Quadrant | | SENSITIVITY | | |
|------------------------------------|--|--|------------|----------|-----|-------------|-----|-----------|
| STWIDOL | TANAMETEN | CONDITIONS | Quadiant | | 10 | 18 | 17 | Unit |
| I _{GT} ⁽¹⁾ | Gate Trigger Current | $V_D = 12 V_{DC}, R_L = 33\Omega, T_j = 25 ^{\circ}C$ | Q1÷Q3 | MAX | 25 | 25 | 50 | mA |
| | | | Q4 | MAX | 25 | 50 | 100 | |
| V _{GT} | Gate Trigger Voltage | $V_D = 12 V_{DC}, R_L = 33\Omega, T_j = 25 °C$ | Q1÷Q4 | MAX | | 1.3 | | V |
| V_{GD} | Gate Non Trigger Voltage | $V_D = V_{DRM}$, $R_L = 3.3 \text{ K}\Omega$, $T_j = 125 \text{ °C}$ | Q1÷Q4 | MIN | | 0.2 | | V |
| I _H ⁽²⁾ | Holding Current | $I_T = 100 \text{ mA,Gate open, } T_j = 25 ^{\circ}\text{C}$ | | MAX | 25 | 25 | 50 | mA |
| IL | Latching Current | $I_{G} = 1.2 I_{GT}, T_{j} = 25 ^{\circ}\text{C}$ | Q1, Q3, Q4 | MAX | 40 | 40 | 70 | mA |
| | | | Q2 | MAX | 60 | 80 | 100 | |
| dV/dt (2) | Critical Rate of Voltage Rise | $V_D = 0.67 \times V_{DRM}$, Gate open | | MIN | 200 | 200 | 400 | V/µs |
| | | T _j = 125 °C | | | | | | |
| (dV/dt)c ⁽²⁾ | Critical Rate of Commutating off-state voltage | (dl/dt)c = 5.3 A/ms $T_j = 125$ °C | | MIN | 3 | 5 | 10 | V/µs |
| V _{TM} ⁽²⁾ | On-state Voltage | $I_T = 17 \text{ Amp, tp} = 380 \mu\text{s}, T_i = 25 ^{\circ}\text{C}$ | | MAX | | 1.55 | | V |
| $V_{t(0)}^{(2)}$ | Threshold Voltage | $T_i = 125 ^{\circ}\text{C}$ | | MAX | | 0.85 | | V |
| r _d ⁽²⁾ | Dynamic resistance | $T_i = 125 ^{\circ}\text{C}$ | | MAX | | 35 | | $m\Omega$ |
| I _{DRM} /I _{RRM} | Off-State Leakage Current | $V_D = V_{DRM}$, $T_i = 125 °C$ | | MAX | | 1 | | mA |
| IDRM/IRRM | On-State Leakage Ourient | $V_R = V_{RRM}$, $T_j = 25$ °C | | MAX | | 5 | | μΑ |
| D | T. 15 | | | IVIAA | | | | |
| $R_{th(j-c)}$ | Thermal Resistance Junction-Case | for AC 360° conduction angle | | | | 1.4 | | °C/W |
| $R_{th(j-a)}$ | Thermal Resistance Junction-Ambient | $S^{(3)} = 1 \text{ cm}^2$ | | | | 45 | | °C/W |

⁽¹⁾ Minimum I_{GT} is guaranted at 5% of I_{GT} max.

Part Number Information



⁽²⁾ For either polarity of electrode 2 voltage with reference to electrode 1.

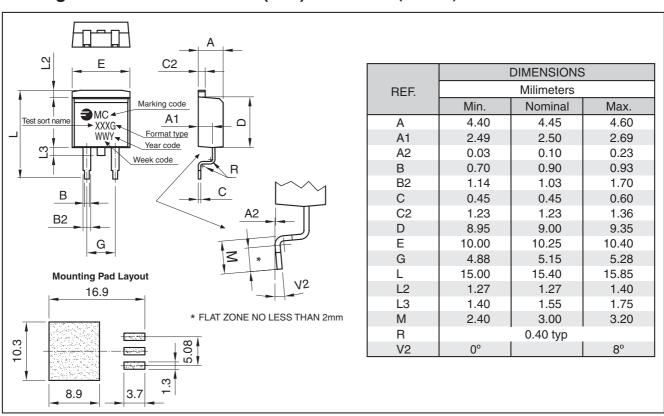
⁽³⁾ S: Cooper surface under tab.



Ordering information

| PREFERRED P/N | PACKAGE CODE | DELIVERY MODE | BASE QUANTITY | UNIT WEIGHT (g) |
|---------------|--------------|----------------------------|---------------|-----------------|
| FT1217MG 00TR | TR | 13" diameter tape and reel | 800 | 1.50 |

Package Outline Dimensions: (mm) TO-263AB (D2PAK)





Ratings and Characteristics (Ta 25 °C unless otherwise noted)

Fig. 1: Maximum power dissipation versus RMS on-state current (full cycle)

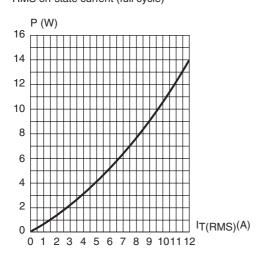


Fig. 3: Relative variation of thermal impedance versus pulse duration.

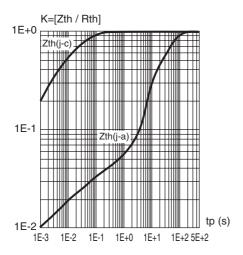


Fig. 5: Surge peak on-state current versus number of cycles

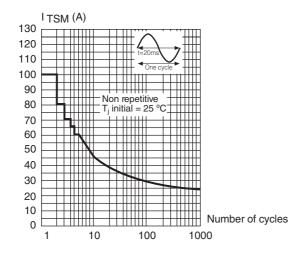


Fig. 2: RMS on-state current versus case temperature (full cycle).

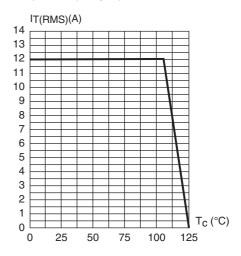


Fig. 4: On-state characteristics (maximum values)

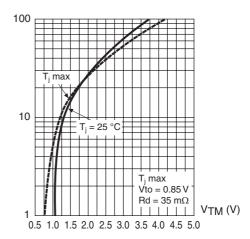
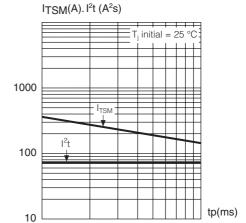


Fig. 6: Non repetitive surge peak on-state current for a sinusoidal pulse with width: tp < 10 ms, and corresponding value of l²t.



10



Ratings and Characteristics (Ta 25 °C unless otherwise noted)

Fig. 7: Relative variation of gate trigger current, holding current and latching versus junction temperature (typical values)

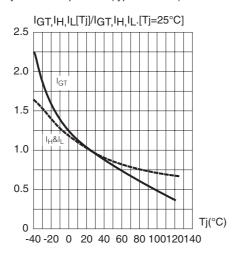


Fig. 9: Relative variation of critical rate of decrease of main current versus

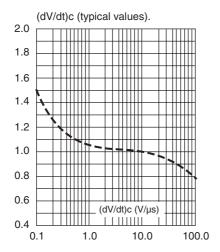


Fig. 8: Relative variation of critical rate of decrease of main current versus junction temperature

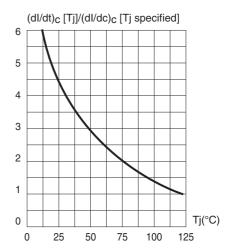
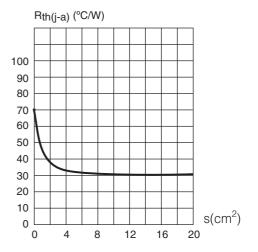


Fig. 10: D2PAK thermal resistance junction to ambient versus copper surface under tab (printed circuit board copper thickness: 35µ)





Revision History

| Date | Revision | Description of Changes |
|---------------|----------|---|
| 10-Jan-2012 | 0 | Original Data Sheet |
| 24-May-2017 1 | | Eliminated: 200V, 700V and Sensitivity 13 |

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